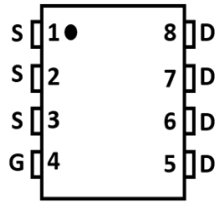
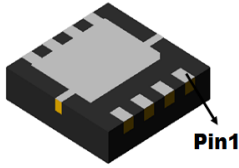
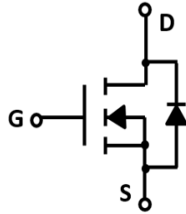


N-Channel Enhancement Mode Field Effect Transistor



DFN3.3X3.3



Product Summary

- V_{DS} 40 V
- I_D 35 A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) < 8.0mohm
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) < 13mohm
- 100% UIS Tested
- 100% ∇V_{DS} Tested

General Description

- Trench Power LV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$

Applications

- High current load applications
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	40	V
Gate-source Voltage		V_{GS}	± 20	V
Drain Current	$T_A=25^\circ\text{C}$	I_D	35	A
	$T_A=100^\circ\text{C}$		22	
Pulsed Drain Current ^A		I_{DM}	160	A
Single Pulse Avalanche Energy ^B		E_{AS}	120	mJ
Total Power Dissipation	$T_C=25^\circ\text{C}$	P_D	40	W
	$T_A=25^\circ\text{C}$		4.1	
Thermal Resistance Junction-to-Case		$R_{\theta JC}$	3.1	$^\circ\text{C}/\text{W}$
		$R_{\theta JA}$	30	
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	$^\circ\text{C}$

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJQ35N04A	F1	Q35N04	5000	10000	100000	13" reel



YJQ35N04A

■ Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=40V, V_{GS}=0V$			1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.5	2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$		6.5	8.0	m Ω
		$V_{GS}=4.5V, I_D=10A$		8.7	13	
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}=0V$		0.7	1.2	V
Maximum Body-Diode Continuous Current	I_S				35	A
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{DS}=20V, V_{GS}=0V, f=1\text{MHz}$		1860		pF
Output Capacitance	C_{oss}			256		
Reverse Transfer Capacitance	C_{rss}			205		
Gate Resistance	R_g	$f=1\text{MHz}$		1.5	2	Ω
Switching Parameters						
Total Gate Charge	Q_g	$V_{GS}=10V, V_{DS}=20V, I_D=20A$		46.7		nC
Gate-Source Charge	Q_{gs}			8		
Gate-Drain Charge	Q_{gd}			11.6		
Reverse Recovery Charge	Q_{rr}	$I_F=20A, di/dt=100A/\mu s$		2.3		ns
Reverse Recovery Time	t_{rr}			15		
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=10V, V_{DD}=20V, I_D=2A, R_L=1\Omega$ $R_{GEN}=3\Omega$		10		ns
Turn-on Rise Time	t_r			21		
Turn-off Delay Time	$t_{D(off)}$			36		
Turn-off fall Time	t_f			25		

A. Pulse Test: Pulse Width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

B. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.



Typical Performance Characteristics

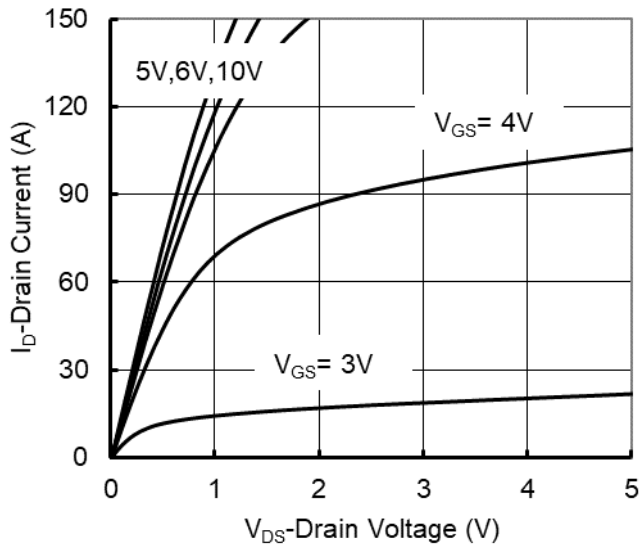


Figure 1. Output Characteristics

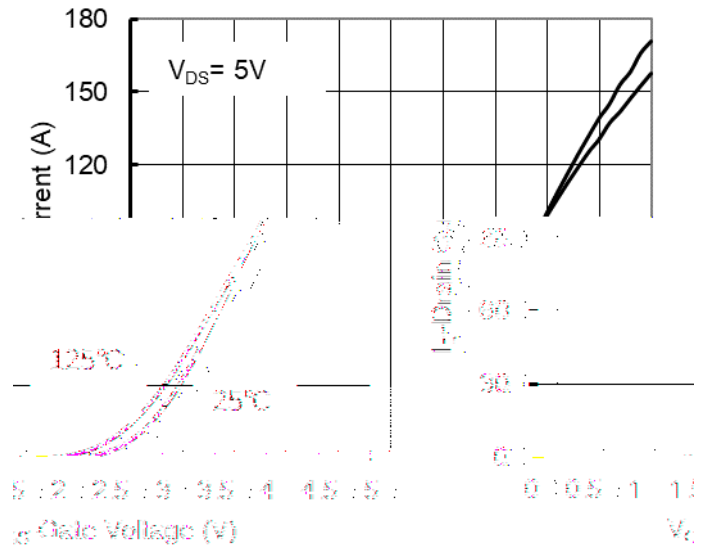


Figure 2. Transfer Characteristics

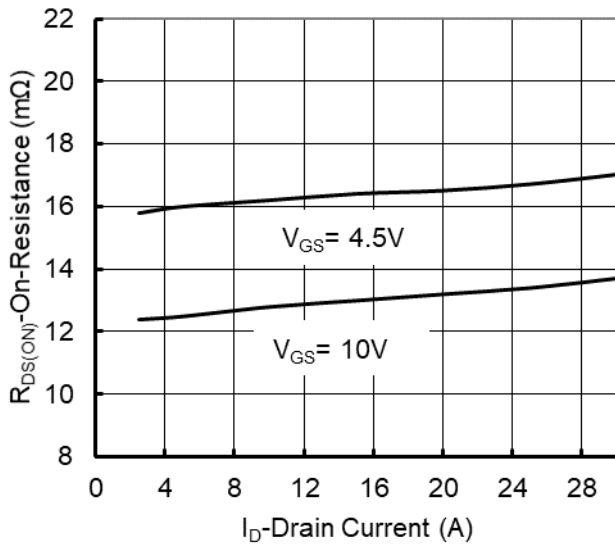


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

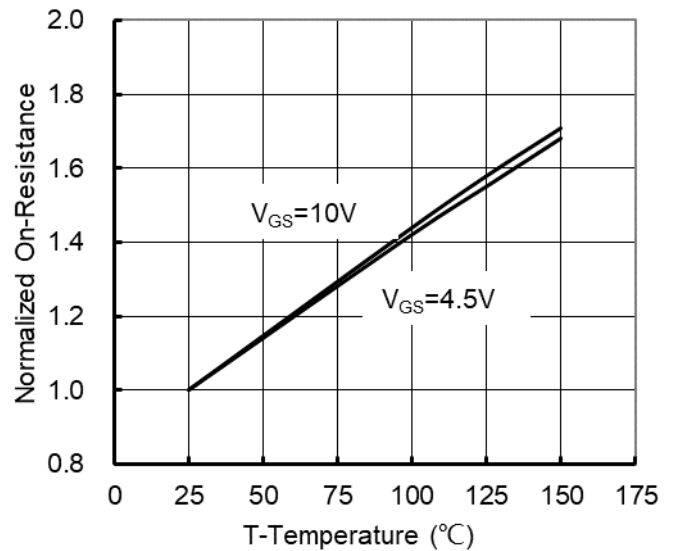


Figure 4. On-Resistance vs. Junction Temperature

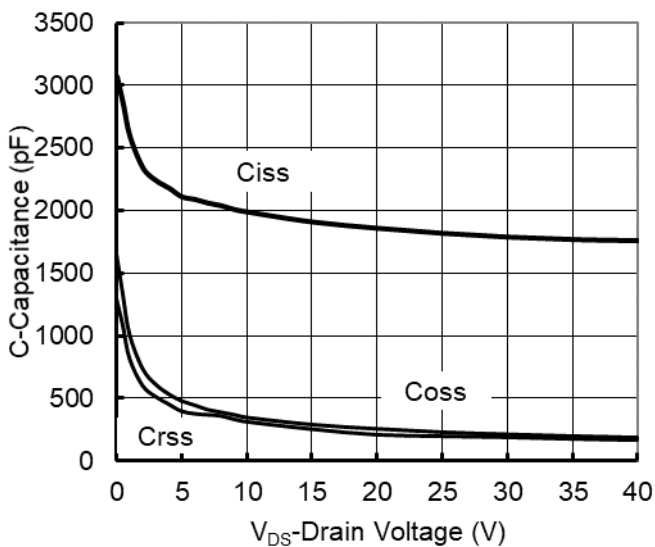


Figure 5. Capacitance Characteristics

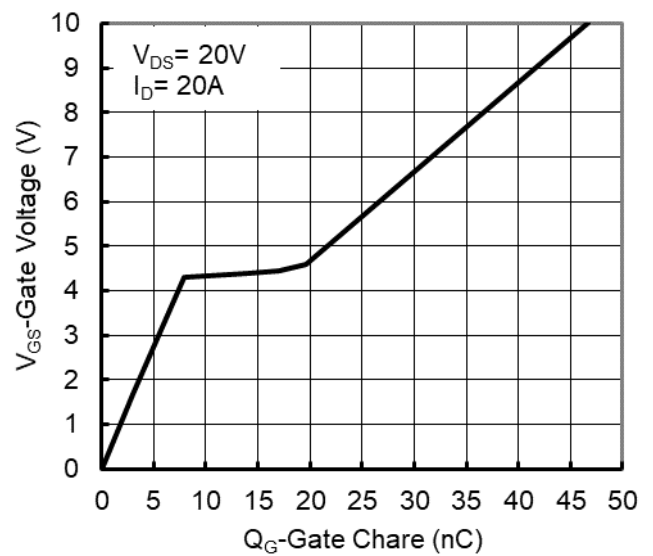


Figure 6. Gate Charge



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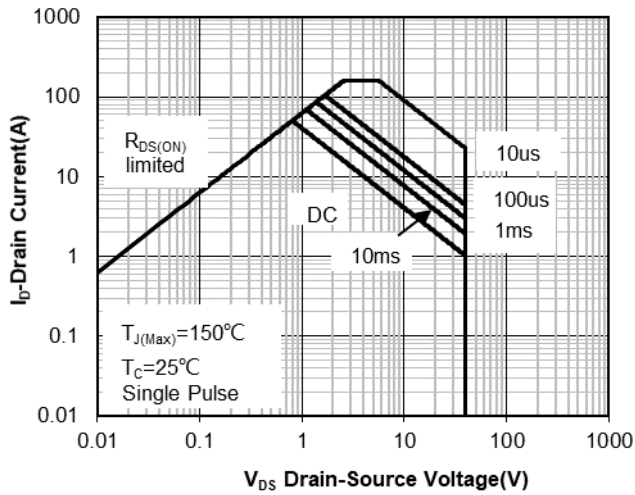


Figure 7. Safe Operation Area

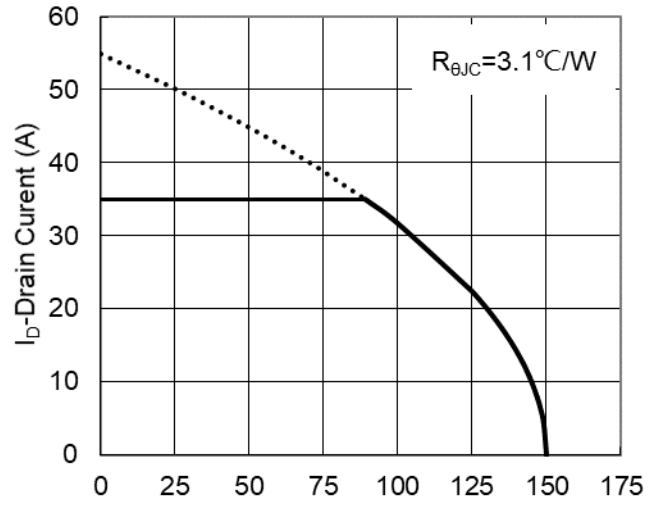


Figure 8. Maximum Continuous Drain Current vs Ambient Temperature

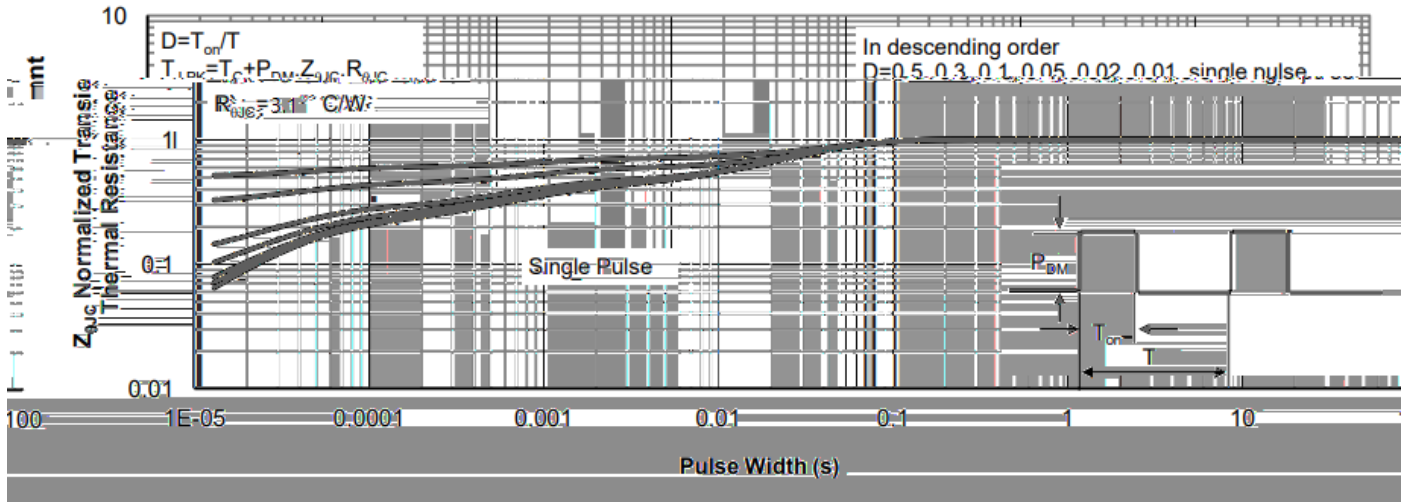
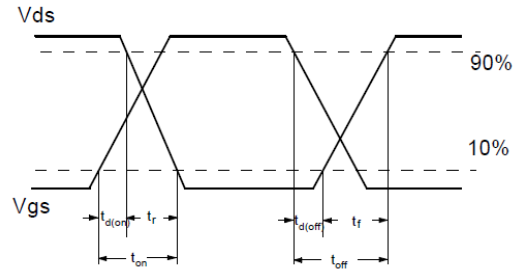
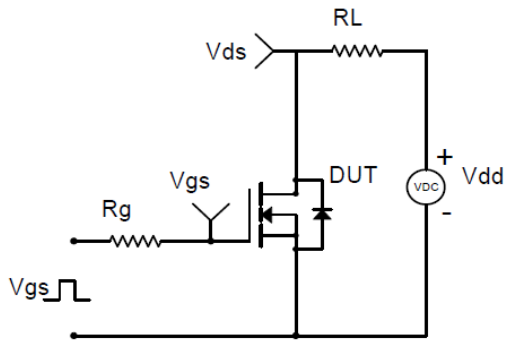
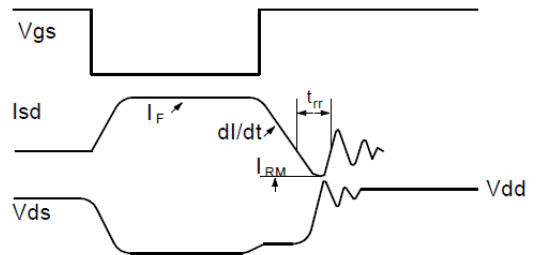
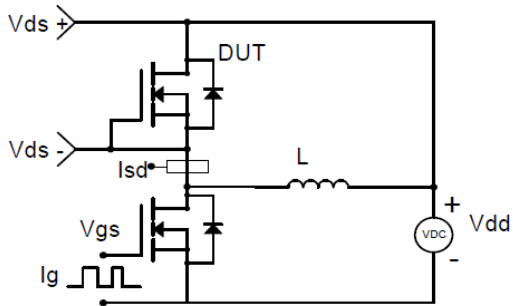


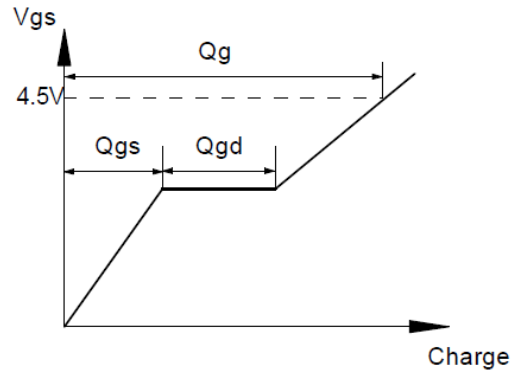
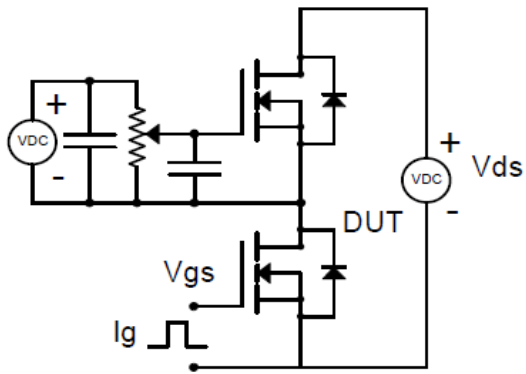
Figure 9. Normalized Maximum Transient Thermal Impedance



Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

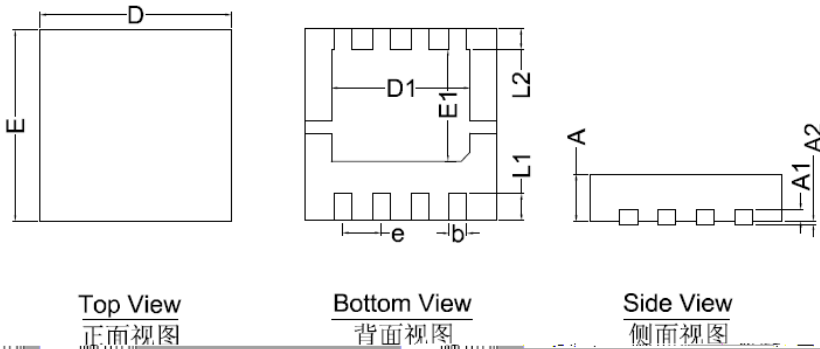


Gate Charge

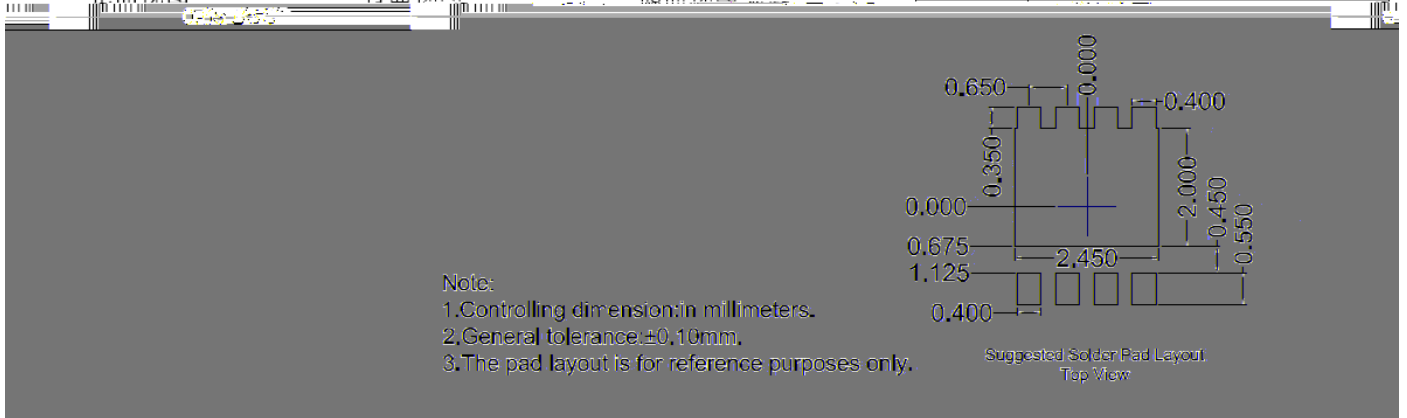


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DFN3.3X3.3 Package information



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3,15	3,25	3,35
E	3,15	3,25	3,35
A	0,70	0,80	0,90
A1	0,20 BSC		
A2			0,10
D1	2,20	2,35	2,50
E1	1,80	1,90	2,00
L1	0,35	0,45	0,55
L2	0,35 BSC		
b	0,20	0,30	0,40





YJQ35N04A

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